**Product Objective Specification**

# P-Channel Enhancement-Mode Vertical DMOS FETs

## Ordering Information

| $BV_{DSS}$ / $BV_{DGS}$ | $R_{DS(ON)}$ (max) | $V_{GS(th)}$ (max) | Order Number/Package | |
|---|---|---|---|---|
| | | | TO-236AB* | Wafer |
| -350V | 30Ω | -2.4V | TP5335K1 | TP5335NW |

*Same as SOT-23. All units shipped on 3,000 piece carrier tape reels.

**Product marking for SOT-23**

**P3S∗**

Where *=2-week alpha date code

## Features

- ☐ Free from secondary breakdown
- ☐ Low power drive requirement
- ☐ Ease of paralleling
- ☐ Low $C_{ISS}$ and fast switching speeds
- ☐ Excellent thermal stability
- ☐ Integral Source-Drain diode
- ☐ High input impedance and high gain
- ☐ Complementary N- and P-channel devices

## Advanced DMOS Technology

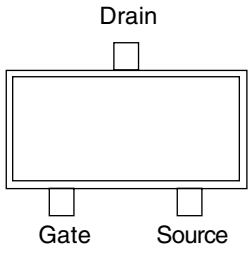
These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Applications

- ☐ Logic level interfaces – ideal for TTL and CMOS
- ☐ Solid state relays
- ☐ Analog switches
- ☐ Power Management
- ☐ Telecom switches

## Package Options




TO-236AB
(SOT-23)
top view

Note: See Package Outline section for dimensions.

## Absolute Maximum Ratings

| | |
|---|---|
| Drain-to-Source Voltage | $BV_{DSS}$ |
| Drain-to-Gate Voltage | $BV_{DGS}$ |
| Gate-to-Source Voltage | ± 20V |
| Operating and Storage Temperature | -55°C to +150°C |
| Soldering Temperature* | 300°C |

* Distance of 1.6 mm from case for 10 seconds.

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# Thermal Characteristics

| Package | $I_D$ (continuous)* | $I_D$ (pulsed) | Power Dissipation @ $T_A$ = 25°C | $\theta_{jc}$ °C/W | $\theta_{ja}$ °C/W | $I_{DR}$* | $I_{DRM}$ |
|---|---|---|---|---|---|---|---|
| SOT-23 | -85mA | -400mA | 0.36W | 200 | 350 | -85mA | -400mA |

* $I_D$ (continuous) is limited by max rated $T_j$.

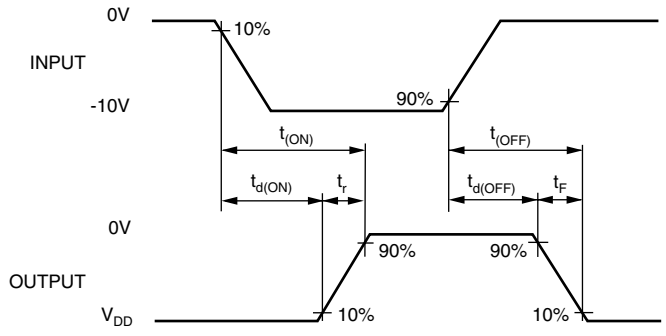
# Electrical Characteristics (@ 25°C unless otherwise specified)

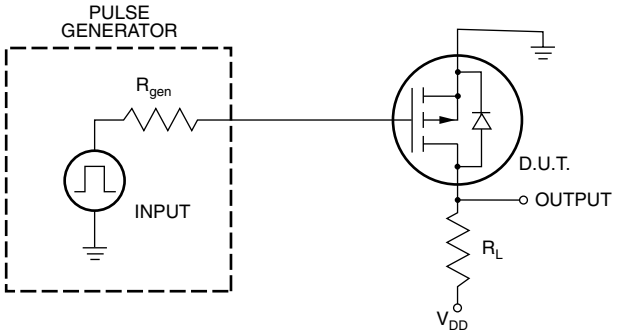
| Symbol | Parameter | Min | Typ | Max | Unit | Conditions |
|---|---|---|---|---|---|---|
| $BV_{DSS}$ | Drain-to-Source Breakdown Voltage | -350 | | | V | $V_{GS}$ = 0V, $I_D$ = -100μA |
| $V_{GS(th)}$ | Gate Threshold Voltage | -1.0 | | -2.4 | V | $V_{GS}$ = $V_{DS}$, $I_D$ = -1.0mA |
| $\Delta V_{GS(th)}$ | Change in $V_{GS(th)}$ with Temperature | | | 4.5 | mV/°C | $V_{GS}$ = $V_{DS}$, $I_D$ = -1.0mA |
| $I_{GSS}$ | Gate Body Leakage | | | -100 | nA | $V_{GS}$ = ±20V, $V_{DS}$ = 0V |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | | | -10 | μA | $V_{GS}$ = 0V, $V_{DS}$ = Max Rating |
| | | | | -1.0 | mA | $V_{GS}$ = 0V, $V_{DS}$ = 0.8 Max Rating<br>$T_A$ = 125°C |
| | | | | -5.0 | nA | $V_{GS}$ = 0V, $V_{DS}$ = -330V |
| $I_{D(ON)}$ | ON-State Drain Current | -200 | | | mA | $V_{GS}$ = -4.5V, $V_{DS}$ = -25V |
| | | -400 | | | | $V_{GS}$ = -10V, $V_{DS}$ = -25V |
| $R_{DS(ON)}$ | Static Drain-to-Source ON-State Resistance | | | 75 | Ω | $V_{GS}$ = -4.5V, $I_D$ = -150mA |
| | | | | 30 | Ω | $V_{GS}$ = -10V, $I_D$ = -200mA |
| $\Delta R_{DS(ON)}$ | Change in $R_{DS(ON)}$ with Temperature | | | 1.7 | %/°C | $V_{GS}$ = -10V, $I_D$ = -200mA |
| $G_{FS}$ | Forward Transconductance | 125 | | | m℧ | $V_{DS}$ = -25V, $I_D$ = -200mA |
| $C_{ISS}$ | Input Capacitance | | | 110 | pF | $V_{GS}$ = 0V, $V_{DS}$ = -25V<br>f = 1 MHz |
| $C_{OSS}$ | Common Source Output Capacitance | | | 60 | | |
| $C_{RSS}$ | Reverse Transfer Capacitance | | | 22 | | |
| $t_{d(ON)}$ | Turn-ON Delay Time | | | 20 | ns | $V_{DD}$ = -25V<br>$I_D$ = -150mA<br>$R_{GEN}$ = 25Ω |
| $t_r$ | Rise Time | | | 15 | | |
| $t_{d(OFF)}$ | Turn-OFF Delay Time | | | 25 | | |
| $t_f$ | Fall Time | | | 25 | | |
| $V_{SD}$ | Diode Forward Voltage Drop | | | -1.8 | V | $V_{GS}$ = 0V, $I_{SD}$ = -200mA |
| $t_{rr}$ | Reverse Recovery Time | | 800 | | ns | $V_{GS}$ = 0V, $I_{SD}$ = -200mA |

**Notes:**

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

# Switching Waveforms and Test Circuit

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